



20V P-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

Product Summary

BV _{DSS}	R _{DS(ON)}	I _D Tc = +25°C
-20V	5.5mΩ @ V _{GS} = -10V	-84A
-20V	7.0mΩ @ V _{GS} = -4.5V	-75A

Description and Applications

This new generation MOSFET is designed to minimize RDS(ON) yet maintain superior switching performance. This device is ideal for use in power management and load switch.

- DC-DC Converters
- Load Switch

Features

- Thermally Efficient Package-Cooler Running Applications
- <1.1mm Package Profile Ideal for Thin Applications
- High Conversion Efficiency
- Low R_{DS(ON)} Minimizes On State Losses
- Low Input Capacitance
- Fast Switching Speed
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative.

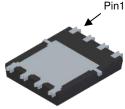
https://www.diodes.com/quality/product-definitions/

Mechanical Data

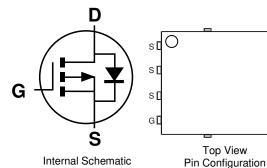
- Case: PowerDI®5060-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram Below
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.097 grams (Approximate)







Bottom View



Ordering Information (Note 4)

Part Number	Case	Packaging
DMP27M1UPSW-13	PowerDI5060-8 (SWP) (Type UX)	2.500 / Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



) :: = Manufacturer's Marking P27M1USW= Product Type Marking Code YYWW = Date Code Marking \overline{YY} = Year (ex: 21 = 2021) WW = Week (01 to 53)

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Maximum Ratings (@ $T_C = +25^{\circ}C$, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	V _{DSS}	-20	V		
Gate-Source Voltage	V_{GSS}	±12	V		
Continuous Drain Current, VGS = 10V (Note 7)	ΙD	-84 -68	А		
Maximum Continuous Body Diode Forward Current (No	ls	-3.8	Α		
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	Ірм	-179	Α		
Pulsed Body Diode Forward Current (10µs Pulse, Duty	Іѕм	-179	Α		
Avalanche Current, L=0.1mH (Note 8)	las	-33	Α		
Avalanche Energy, L=0.1mH (Note 8)			Eas	54	mJ

Thermal Characteristics (@Tc = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	T _A = +25°C	PD	1.95	W
Thermal Resistance, Junction to Ambient (Note 5)		R _θ JA	64	°C/W
Total Power Dissipation (Note 6)	$T_{C} = +25^{\circ}C$	P_{D}	3.57	W
Thermal Resistance, Junction to Case (Note 6)		Rejc	35	°C/W
Thermal Resistance, Junction to Case (Note 7)		Rejc	2.1	°C/W
Operating and Storage Temperature Range		T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics (@ $T_C = +25$ °C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 9)							
Drain-Source Breakdown Voltage	BVDSS	-20		_	V	$V_{GS} = 0V$, $I_{D} = -250\mu A$	
Zero Gate Voltage Drain Current	IDSS		_	-1	μΑ	$V_{DS} = -16V$, $V_{GS} = 0V$	
Gate-Source Leakage	IGSS	_	_	±100	nA	$V_{GS} = \pm 8V$, $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 9)							
Gate Threshold Voltage	V _{GS(TH)}	-0.4	1	-1.3	V	$V_{DS}=V_{GS},I_D=-250\mu A$	
			3.6	5.5		$V_{GS} = -10V, I_{D} = -15A$	
Static Drain-Source On-Resistance	RDS(ON)		4.4	7.0	mΩ	$V_{GS} = -4.5V$, $I_{D} = -15A$	
		_	6.5	9.0		$V_{GS} = -2.5V$, $I_{D} = -10A$	
Diode Forward Voltage	V_{SD}	_	-0.7	-1.2	V	V _G S = 0V, I _S = -10A	
DYNAMIC CHARACTERISTICS (Note 10)							
Input Capacitance	Ciss		4777	_		V _{DS} = -10V, V _{GS} = 0V f = 1.0MHz	
Output Capacitance	Coss	_	591	_	pF		
Reverse Transfer Capacitance	Crss	_	518	_			
Gate Resistance	Rg	_	2.9	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1.0MHz$	
Total Gate Charge (VGS = -4.5V)	Qg	_	55	_		V _{DD} = -10V, I _D = -20A	
Total Gate Charge (V _{GS} = -10V)	Qg	_	123	_	nC		
Gate-Source Charge	Qgs	_	9.6	_	nc nc		
Gate-Drain Charge	Q_{gd}	_	15.9	_			
Turn-On Delay Time	t _{D(ON)}	_	25	_		$V_{GS} = -4.5V, V_{DD} = -10V,$ $R_{G} = 1\Omega, I_{D} = -10A$	
Turn-On Rise Time	tr	_	84	_			
Turn-Off Delay Time	tD(OFF)	_	120	_	ns		
Turn-Off Fall Time	tr		128	_			
Reverse Recovery Time	trr	_	20	_	ns	1 - 404 - 404 - 4004	
Reverse Recovery Charge	Qrr	_	11	_	nC	-I _F = -10A, di/dt = 100A/μs	

Notes: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

^{6.} Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
7. Thermal resistance from junction to soldering point (on the exposed drain pad).

^{8.} I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep T_J = +25°C.

^{9.} Short duration pulse test used to minimize self-heating effect.

^{10.} Guaranteed by design. Not subject to product testing.



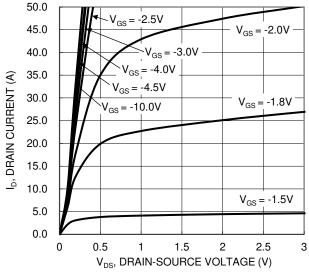


Figure 1. Typical Output Characteristic

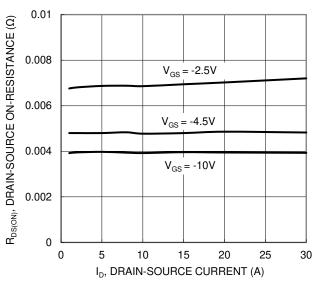


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

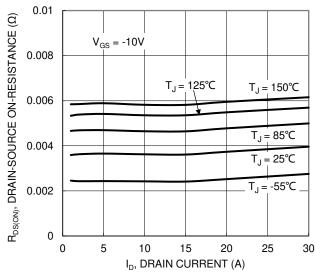


Figure 5. Typical On-Resistance vs. Drain Current and Temperature

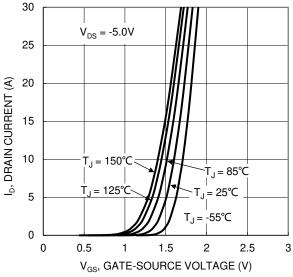


Figure 2. Typical Transfer Characteristic

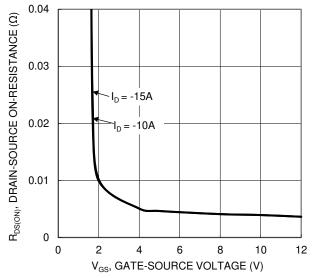


Figure 4. Typical Transfer Characteristic

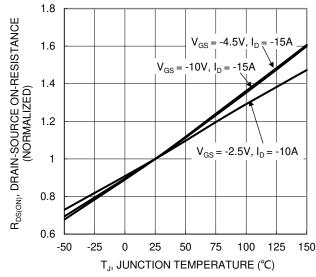


Figure 6. On-Resistance Variation with Temperature



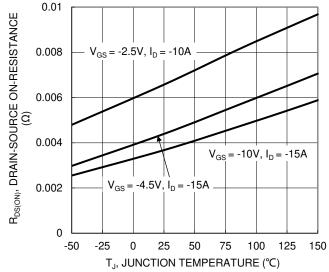


Figure 7. On-Resistance Variation with Temperature

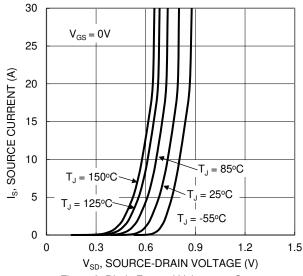


Figure 9. Diode Forward Voltage vs. Current

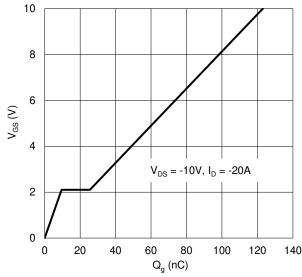


Figure 11. Gate Charge

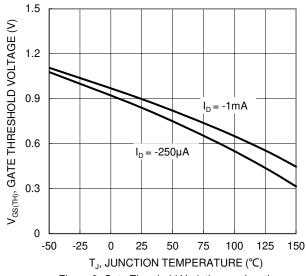
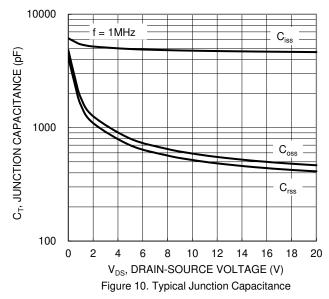


Figure 8. Gate Threshold Variation vs. Junction Temperature



1000 $P_W = 1 \mu s$ $P_W = 10\mu s$ $P_W = 100 \mu s$ 100 ID, DRAIN CURRENT (A) $P_W = 1ms$ $P_W = 10ms$ = 100 ms10 P_w = 1s T_{J(Max)} = 150°C T_C = 25 °C Single Pulse DUT on Infinite Heatsink $V_{GS} = -10V$ 0.1 0.1 10 100 1000 V_{DS}, DRAIN-SOURCE VOLTAGE (V) Figure 12. SOA, Safe Operation Area



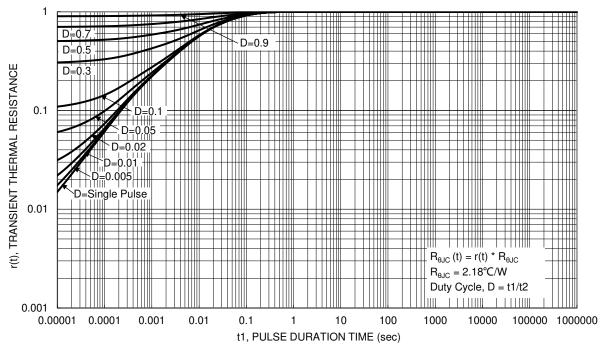


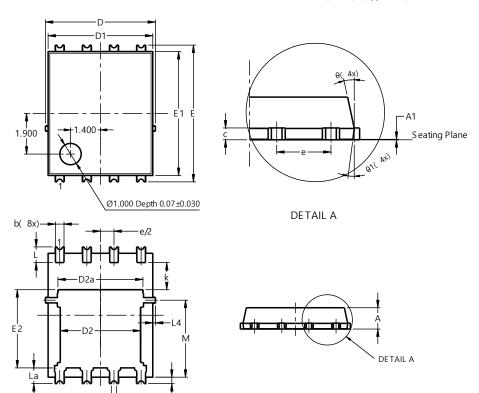
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8 (SWP) (Type UX)



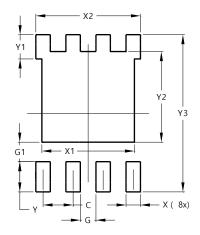
PowerDI5060-8 (SWP) (Type UX)					
Dim	Min	Max	Тур		
Α	0.90	1.10	1.00		
A1	0	0.05			
b	0.30	0.50	0.41		
b2	0.20	0.35	0.25		
b4	().25REF			
С	0.230	0.330	0.277		
D	5	.15 BS0	5		
D1	4.70	5.10	4.90		
D2	3.56	3.96	3.76		
D2a	3.78 4.18 3.9				
Е	6.40 BSC				
E1	5.60	6.00	5.80		
E2	3.46	3.86	3.66		
E2a	4.195	4.595	4.395		
е	1	.27BSC)		
k	1.05				
L	0.635	0.835	0.735		
La	0.635	0.835	0.735		
L1	0.200	0.400	0.300		
L1a	0.050REF				
L4	0.025	0.225	0.125		
М	3.205	4.005	3.605		
θ	10°	12°	11°		
θ1	6° 8° 7°				
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

-b4(8x)

PowerDI5060-8 (SWP) (Type UX)



Dimensions	Value		
Dilliciisions	(in mm)		
С	1.270		
G	0.660		
G1	0.820		
X	0.610		
X1	4.100		
X2	4.420		
Υ	1.270		
Y1	1.020		
Y2	3.810		
Y3	6.610		



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